

Technical Data Sheet

Schulamid 6 GF50 HE NAT



Polyamide 6

Product Description

50% glass fiber reinforced PA 6, high strength and stiffness, heat stabilized

Processing Method	Injection Molding
Attribute	Heat Stabilized; High Stiffness; High Strength
Additive	Heat Stabilizer
Filler/Reinforcement	Glass Fiber, 50%

Typical Properties	Nominal Value	Units	Test Method
Physical			
Density, (Method A)	1.55	g/cm ³	ISO 1183
Viscosity Number	145	cm ³ /g	ISO 307
Mechanical			
Tensile Strain at Break			
(Type 1A, 5 mm/min)	2.0	%	ISO 527-2
(Type 1A, 5 mm/min) - Conditioned	3.0	%	ISO 527-2
Tensile Stress at Break			
(Type 1A, 5 mm/min)	210	MPa	ISO 527-2
(Type 1A, 5 mm/min) - Conditioned	150	MPa	ISO 527-2
Tensile Modulus			
(1 mm/min, Type 1A)	16000	MPa	ISO 527-1
(1 mm/min, Type 1A) - Conditioned	10000	MPa	ISO 527-1
Impact			
Charpy Impact Strength - Notched			
(23 °C, Type 1, Edgewise, Notch A)	15	kJ/m ²	ISO 179
(23 °C, Type 1, Edgewise, Notch A) - Conditioned	28	kJ/m ²	ISO 179
Charpy Impact Strength - Unnotched			
(23 °C, Type 1, Edgewise)	100	kJ/m ²	ISO 179
(23 °C, Type 1, Edgewise) - Conditioned	110	kJ/m ²	ISO 179
Hardness			
Ball Indentation Hardness, (H 358/30)	280	MPa	ISO 2039-1
Ball Pressure Test, (190 °C)	Pass		IEC 60695-10-2
Thermal			
Vicat Softening Temperature, (B (50N), 50 °C/h)	215	°C	ISO 306

Deflection Temperature Under Load Unannealed (0.45 MPa), (Flatwise)	215	°C	ISO 75-2/B
Deflection Temperature Under Load Unannealed (1.80 MPa), (Flatwise)	210	°C	ISO 75-2/A
Electrical			
Volume Resistivity	>1.0E+13	ohm*m	IEC 62631-3-1
- Conditioned	10000000000	ohm*m	IEC 62631-3-1
Comparative Tracking Index (CTI)	450	V	IEC 60112
Surface Resistivity	>1.0E+15	ohm	IEC 60093
Flammable			
Burning Rate			
(2.00 mm)	<100	mm/min	FMVSS 302
(2.00 mm)	<100	mm/min	ISO 3795
Glow Wire Flammability Index	650	°C	IEC 60695-2-12
UL Information			
Flammability Classification, (0.75 mm)	HB		IEC 60695-11-10, -20

Injection Parameters		Nominal Value	Units
Drying Time		3.0 to 4.0	hr
Drying Temperature		80	°C
Suggested Max Moisture		0.040 to 0.10	%
Processing (Melt) Temp		250 to 280	°C
Mold Temperature		60 to 100	°C